

Low frequency transistor (12V, 500mA)

## Datasheet

(3)

2SC5585

(EMT3)

SOT-416

Parameter	Value
V <sub>CEO</sub>	12V
Ι <sub>C</sub>	500mA

#### Features

1)High current.

2)Low V<sub>CE(sat)</sub>

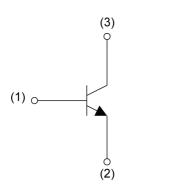
V<sub>CE(sat)</sub>≦250mV at I<sub>C</sub>=200mA/I<sub>B</sub>=10mA

## Application

LOW FREQUENCY AMPLIFIER, DRIVER

## Inner circuit

2SC5663



(1) Base

(2) Emitter

(3) Collector

2SC5585

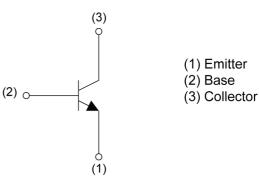
Outline

SOT-723

(3)

2SC5663

(VMT3)



## Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
2SC5663	SOT-723 (VMT3)	1212	T2L	180	8	8000	BX
2SC5585	SOT-416 (EMT3)	1616	TL	180	8	3000	BX

## • Absolute maximum ratings ( $T_a = 25^{\circ}C$ )

Parameter			Values	Unit
Collector-base voltage		V <sub>CBO</sub>	15	V
Collector-emitter voltage		V <sub>CEO</sub>	12	V
Emitter-base voltage		V <sub>EBO</sub>	6	V
Collector current		Ι <sub>C</sub>	500	mA
		I <sub>CP</sub> *1	1.0	А
Deven die ein offen	2SC5663	D *2	150	
Power dissipation	2SC5585		150	mW
Junction temperature		Tj	150	°C
Range of storage temperature		T <sub>stg</sub>	-55 to +150	°C

## • Electrical characteristics (T<sub>a</sub> = 25°C)

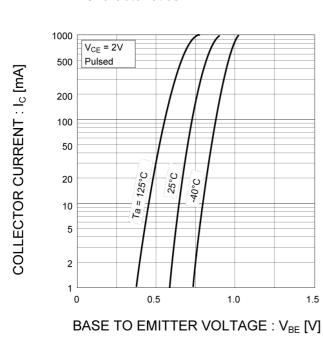
Deremeter	Cymab al	Conditions	Values			L Locit	
Parameter Sy		Symbol Conditions		Тур.	Max.	Unit	
Collector-base breakdown voltage	BV <sub>CBO</sub>	$BV_{CBO} = 10\mu A$ $BV_{CEO} = 1mA$		-	-	V	
Collector-emitter breakdown voltage	BV <sub>CEO</sub>			-	-	V	
Emitter-base breakdown voltage	BV <sub>EBO</sub> I <sub>E</sub> = 10μA		6	-	-	V	
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 15V	-	-	100	nA	
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 6V	-	-	100	nA	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = 200mA, I <sub>B</sub> = 10mA	-	90	250	mV	
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> = 2V, I <sub>C</sub> = 10mA	270	-	680	-	
Transition frequency	f <sub>T</sub>	V <sub>CE</sub> = 2V, I <sub>E</sub> = -10mA, f = 100MHz	-	320	-	MHz	
Output capacitance	C <sub>ob</sub>	V <sub>CB</sub> = 10V, I <sub>E</sub> = 0A, f = 1MHz	-	7.5	-	pF	

\*1 Pw=1ms, Single Pulse.

\*2 Each terminal mounted on a reference land.



### • Electrical characteristic curves(T<sub>a</sub> = 25°C)



#### Fig.1 Ground Emitter Propagation Characteristics

I<sub>B</sub>= 700 μA 600 μA 200 500 µA 180 COLLECTOR CURRENT : I<sub>c</sub> [mA] 160 400 µA 140 300 µA 120 100 80 200 µA 60 100 µA 40 20 Ta = 25°C Pulsed 0 0.5 1 1.5 2 0

#### Fig.2 Typical Output Characteristics

COLLECTOR TO EMITTER VOLTAGE :  $V_{CE}$  [V]

## Fig.3 DC Current Gain vs. Collector Current (I)

DC CURRENT GAIN : h<sub>FE</sub>

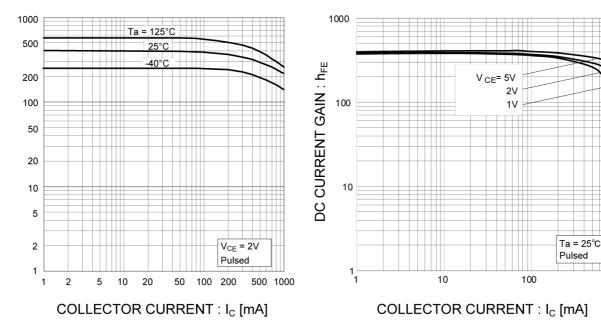
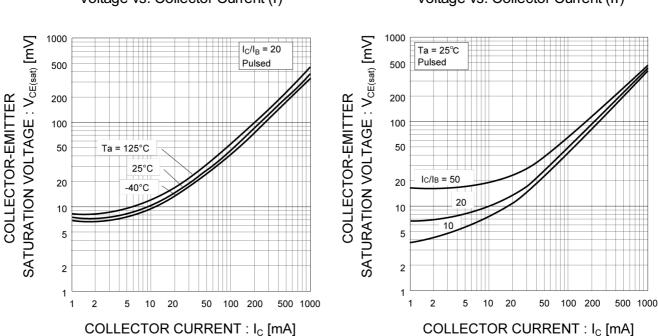


Fig.4 DC Current Gain vs. Collector Current (II)



1000

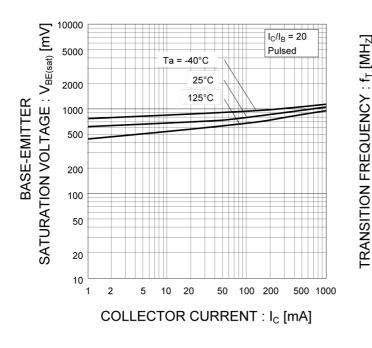
## • Electrical characteristic curves( $T_a = 25^{\circ}C$ )



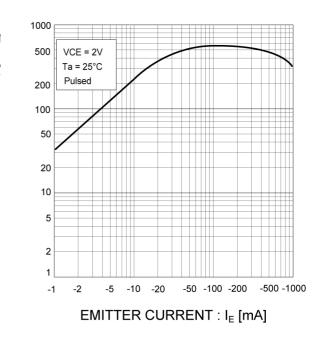
#### Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current (I)

Fig.6 Collector-Emitter Saturation Voltage vs. Collector Current (II)

# Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

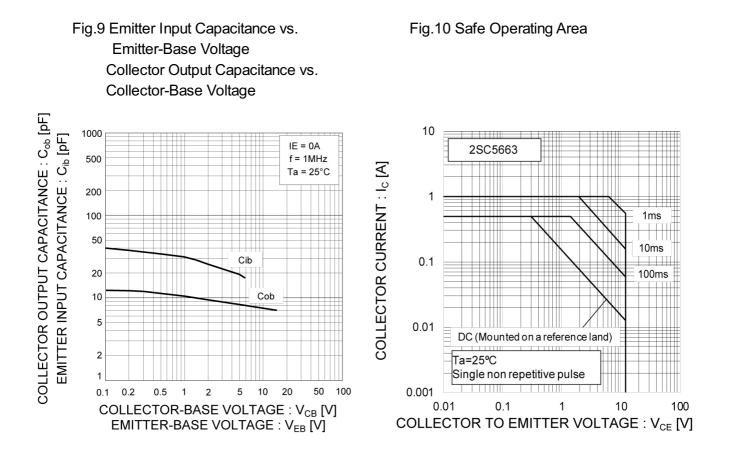


## Fig.8 Gain Bandwidth Product vs. Emitter Current

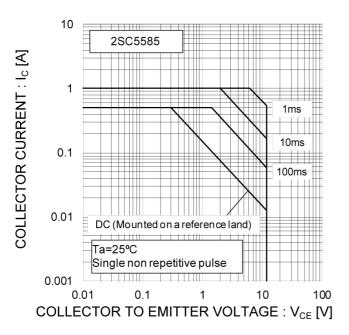




## • Electrical characteristic curves(T<sub>a</sub> = 25°C)



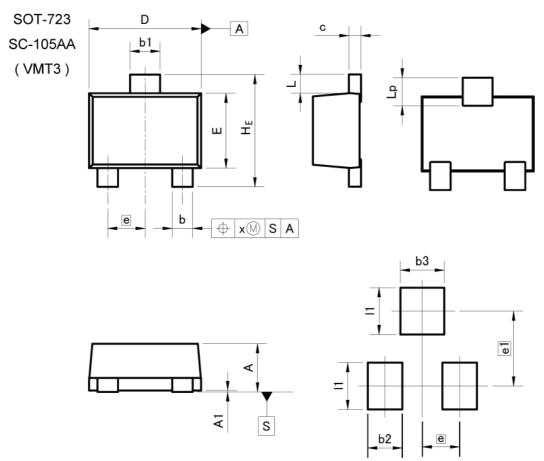
#### Fig.11 Safe Operating Area







#### Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
A	0.45	0.55	0.018	0.022	
A1	0.00	0.10	0.000	0.004	
b	0.17	0.27	0.007	0.011	
b1	0.27	0.37	0.011	0.015	
с	0.08	0.18	0.003	0.007	
D	1.10	1.30	0.043	0.051	
E	0.70	0.90	0.028	0.035	
е	0.40		0.02		
HE	1.10	1.30	0.043	0.051	
L	0.10	0.30	0.004	0.012	
Lp	0.20	0.40	0.008	0.016	
x	-	0.10	-	0.004	
DIM	MILIMETERS		IETERS INCHES		
DIM	MIN	MAX	MIN	MAX	
b2	-	0.37	-	0.015	
b3	-	0.47	-	0.019	
e1	0.	80	0.031		
1	-	0.50	-	0.020	

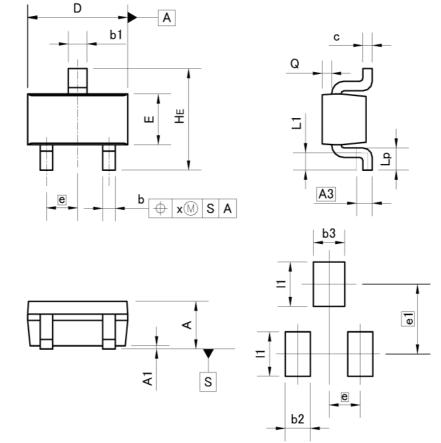
Dimension in mm/inches



#### Dimensions



(EMT3)



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
с	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.50		0.020	
HE	1.40	1.80	0.055	0.071
L1	0.10		0.004	-
Lp	0.15	-	0.006	-
Q	0.05	0.25	0.002	0.010
х	1.77	0.10	-	0.004

DIM	MILIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX	
b2	-	0.40	-	0.016	
b3	-	0.50	-	0.020	
e1	1.10 - 0.70		0.0	43	
1			-	0.028	

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications
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	JAPAN	USA	EU	CHINA
	CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
	CLASSⅣ	CLASSIII	CLASSⅢ	CLASSII

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  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
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- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### **Precautions Regarding Application Examples and External Circuits**

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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